### **Power Transistors**

## **Panasonic**

# 2SD1253, 2SD1253A

## Silicon NPN triple diffusion planar type

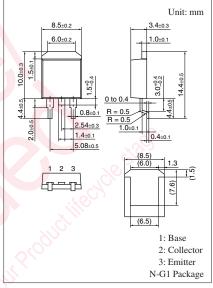
#### For power amplification

Complementary to 2SB0930, 2SB0930A

#### Features

- $\bullet$  High forward current transfer ratio  $h_{F\!E}$  which has satisfactory linearity
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$ Symbol Unit Parameter Rating 2SD1253 V Collector-base voltage V<sub>CBO</sub> 60 (Emitter open) 2SD1253A 80 2SD1253 V V<sub>CEO</sub> 60 Collector-emitter voltage (Base open) 2SD1253A 80 Emitter-base voltage (Collector open) V<sub>EBO</sub> V 5 4 Collector current $I_C$ Α Peak collector current I<sub>CP</sub> 8 Α Collector power dissipation 40 W $P_C$ $T_a = 25^{\circ}C$ 1.3 150 °C Junction temperature Ti Storage temperature -55 to +150 °C T<sub>stg</sub>



Note) Self-supported type package is also prepared.

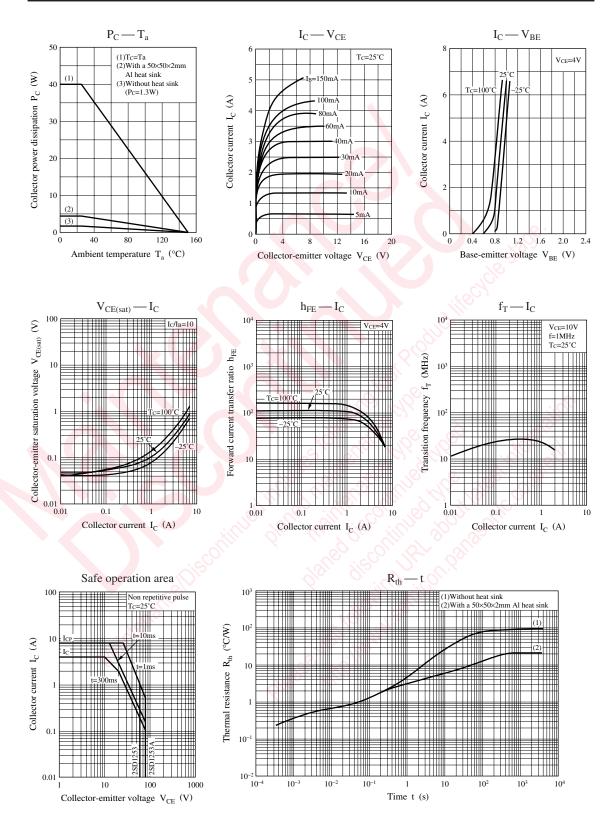
#### Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1253	V <sub>CEO</sub>	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 0$	60	-011		V
(Base open)	2SD1253A	Ni.	die la gro diffe	80	5		
Collector-emitter cutoff	2SD1253	I <sub>CES</sub>	$V_{CE} = 60 \text{ V}, V_{BE} = 0$	0		400	μΑ
current (E-B short)	2SD1253A		$V_{CE} = 80 V, V_{BE} = 0$	0.7		400	
Collector-emitter cutoff	2SD1253	I <sub>CEO</sub>	$V_{CE} = 30 \text{ V}, I_B = 0$			700	μΑ
current (Base open)	2SD1253A		$V_{CE} = 60 \text{ V}, I_B = 0$			700	
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = 5 V, I_C = 0$			1	mA
Forward current transfer ratio		h <sub>FE1</sub> *	$V_{CE} = 4 V, I_C = 1 A$	40		250	0
		h <sub>FE2</sub>	$V_{CE} = 4 V, I_C = 3 A$	15			
Base-emitter voltage		V <sub>BE</sub>	$V_{CE} = 4 V, I_C = 3 A$			2.0	V
Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	$I_{\rm C} = 4 \text{ A}, I_{\rm B} = 0.4 \text{ A}$			1.5	V
Transition frequency		$f_{T}$	$V_{CE} = 5 \text{ V}, I_C = 0.5 \text{ A}, f = 1 \text{ MHz}$		30		MHz
Turn-on time		t <sub>on</sub>	$I_C = 4 A$		0.4		μs
Strage time		t <sub>stg</sub>	$I_{B1} = 0.4 A, I_{B2} = -0.4 A$		1.2		μs
Fall time		t <sub>f</sub>	$V_{CC} = 50 \text{ V}$		0.5		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Rank classification

Rank	R	Q	Р
$h_{\rm FE1}$	40 to 90	70 to 150	120 to 250

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